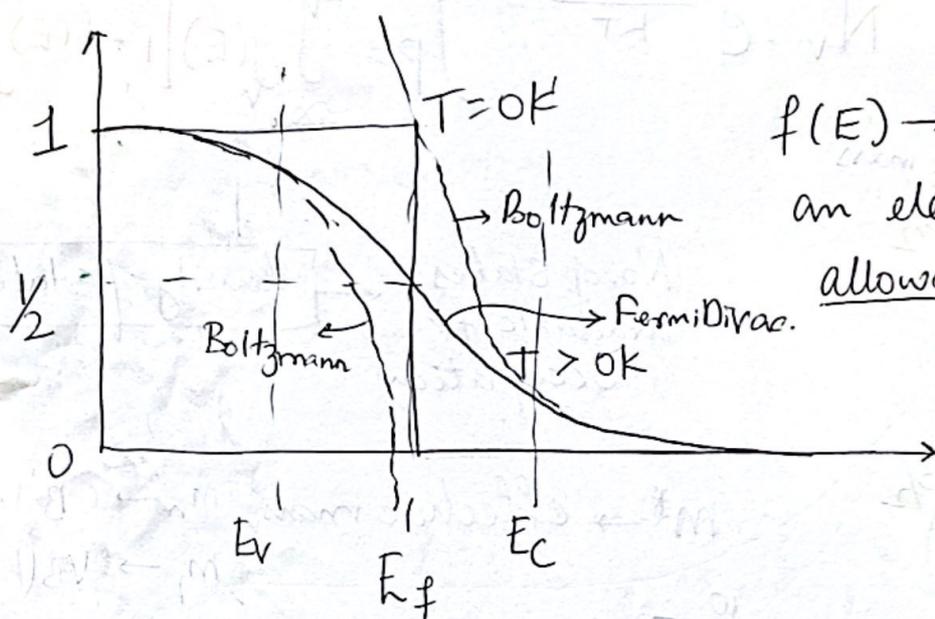


Carrier distribution

> Electrons  $\rightarrow$  Fermions  $\Rightarrow$  Fermi Dirac Distribution.

$$f(E) = \frac{1}{1 + e^{(E-E_F)/kT}}$$

$k \rightarrow$  Boltzmann const.  
 $1.38 \times 10^{-23} \frac{m^2 kg}{s^2 K}$  or  $J/K$



$f(E) \rightarrow$  Probability that an electron fills an allowable Energy state  $E$ .

$E_f \rightarrow$  Fermi level  $\rightarrow f(E) = \frac{1}{2}$  (doesn't mean electron will be here since there may not be an allowable state here).

> When studying conduction band we approximate with Boltzmann distribution. Same for valence band.

CB  $\Rightarrow f(E) \approx e^{-(E-E_f)/kT}$        $E - E_f > 3kT$

VB  $\Rightarrow f(E) \approx 1 - e^{-(E-E_f)/kT}$        $E - E_f < -3kT$   
 $\hookrightarrow$  Taylor  $\frac{1}{x+1} \approx 1-x$  when  $x$  is small.

⇒ number of electrons in conduction band per unit volume  
(aka carrier concentration)

$$n \propto e^{-\frac{(E_c - E_f)}{kT}}$$

$$\Rightarrow n = N_c \cdot e^{\frac{E_f - E_c}{kT}} \quad \left\{ n = \int_{E_c}^{\infty} g_c(E) f(E) dE \right.$$

$$\text{Similarly } p = N_v \cdot e^{\frac{E_v - E_f}{kT}} \quad \left\{ p = \int_{-\infty}^{E_v} g_v(E) [1 - f(E)] dE \right.$$

effective density of states at edge of CB/VB.  
effective mass

$$N_c = 2 \left( \frac{2\pi m_n^* kT}{h^2} \right)^{3/2}$$

No. of states available for occupation

density of states

$$N_v = 2 \left( \frac{2\pi m_p^* kT}{h^2} \right)^{3/2}$$

$m^*$  → effective mass  $m_n$  → CB (electron)  
 $m_p$  → VB (hole)

> Intrinsic Si ⇒  $n = p = n_i = 10^{10} \text{ cm}^{-3}$   
 $n = N_c e^{\frac{E_f - E_c}{kT}} = N_v e^{\frac{E_v - E_f}{kT}}$

Where  $E_i = E_f$  for intrinsic silicon. ⇒  $N_c = n_i e^{\frac{E_c - E_i}{kT}}$

$$N_v = n_i e^{\frac{E_i - E_v}{kT}}$$

$$\Rightarrow n = n_i e^{\frac{E_f - E_i}{kT}}$$

$$p = \frac{n_i}{k} e^{\frac{E_i - E_f}{kT}} \quad \left[ n_p = n_i^2 \right]$$

$E_f > E_i$  ⇒ more electrons (donor) → n-type sc.

$E_f < E_i$  ⇒ more holes (acceptors) → p-type sc.

# Motion of free carriers

## Diffusion

- > Motion of charge carriers due to concentration gradient.
- > Random process due to thermal energy.

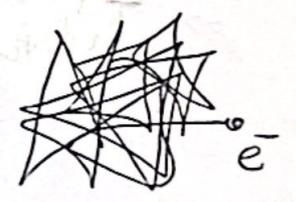
Equipartition Theorem

> Thermal velocity  $v_{th} \approx 10^5 \text{ m/s}$

$$\left[ \frac{1}{2} m_n^* v_{th}^2 = \frac{3}{2} kT \right]$$

in 3D  
effective mass.

- > In Silicon average time between collisions
  - mean free path ( $\lambda$ )  $\rightarrow 10^{-8} \text{ m}$
  - mean scattering time ( $\tau_c$ )  $\rightarrow 10^{-13} \text{ s}$
  - $\Rightarrow \lambda = v_{th} \tau_c$



$J_{diffusion} \propto -\frac{dn}{dx}$   $\rightarrow$  gradient of charge carrier concentration

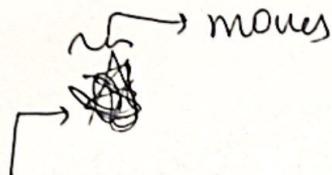
$$J_{n\text{diff}} = q D_n \frac{dn}{dx}$$

$\rightarrow$  Diffusion constant.

$$J_{p\text{diff}} = -q D_p \frac{dp}{dx}$$

$$D_n = \frac{kT}{q} \mu_n, \quad D_p = \frac{kT}{q} \mu_p \rightarrow \text{Einstein relations.}$$

# Drift



> Motion (avg) of charge carriers under an applied Electric field.

> For a free space electron  $F = ma = qE$

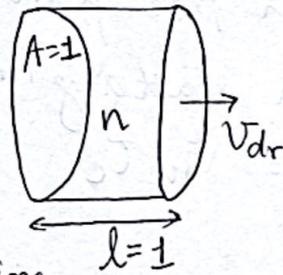
> In a lattice, due to scattering  $v_{dr} = -\mu_n E$   
 $\mu_n$   $\rightarrow$  mobility

$$\mu_n = \frac{q \tau_c}{m_n^*}$$

$$v_{dr} = \left( \frac{qE}{m^*} \right) \tau_c$$

$$\Rightarrow J_{drift} = (-q) n v_{dr}$$

no. of charge carriers passing A per unit time.



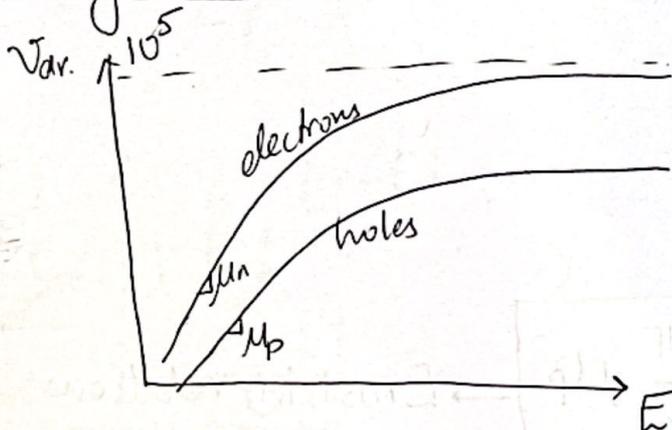
$$J_{drift} = nq \mu_n E$$

Typically (1V over 1mm)

$$\Rightarrow v_{dr} \approx 100 \text{ m/s}$$

$$J_{drift} = q(n \mu_n + p \mu_p) E$$

Velocity Saturation  $\rightarrow \sigma$  (Microscopic picture of  $\sigma$ )

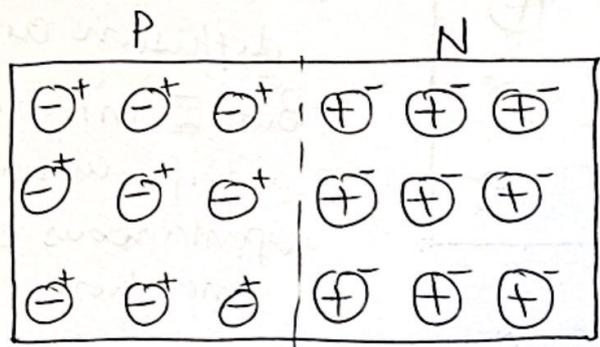


> At high fields  $\mu \rightarrow 0$ .

Modern MOSFETs operate in this regime since E is very high in short channel devices.

# PN Junction

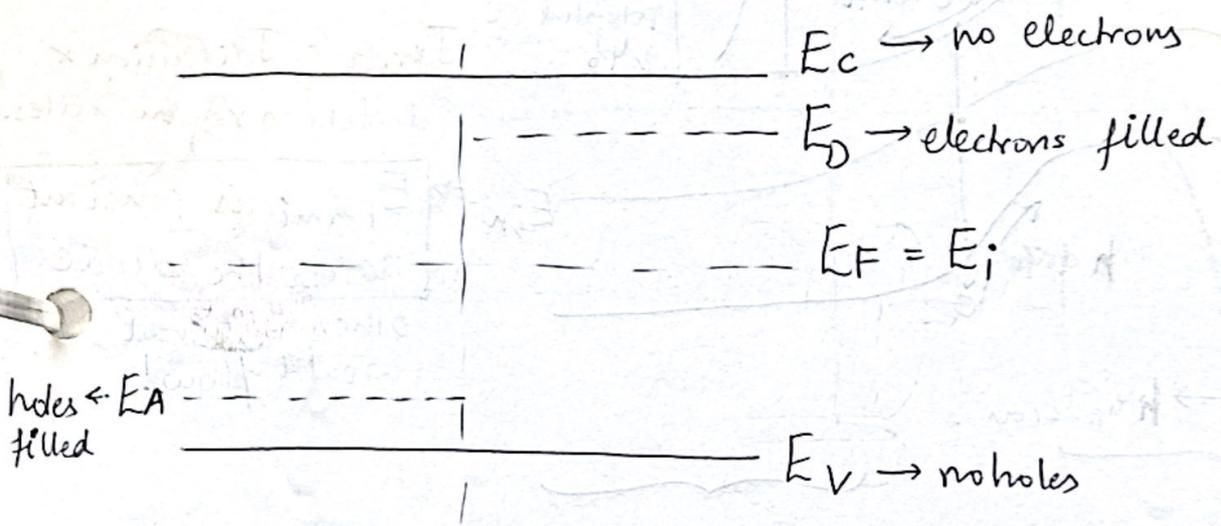
At T=0K



> Charge neutral

> Frozen!

> Note the large gradient in carrier concentration  $\Rightarrow$  Diffusion (but  $T=0K$ )



> When  $T > 0K$ , electrons in  $E_D$  are 'released' to  $E_C$ , i.e. they become free electrons in the lattice. Similarly  $E_V \rightarrow E_A$  electrons leave behind "free holes" & start moving around.

> At the boundary these free electrons & holes recombine, leaving behind ions in a so called Depletion region.

> This process happens very rapidly and a "built in" potential develops across the boundary.